EE 435

Lecture 33

Switches
Current Steering DACs

R-String DAC

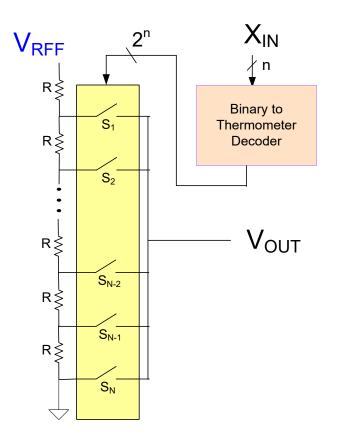
If all components are ideal, performance of the R-string DAC is that of an ideal DAC!

Key Properties of R-String DAC

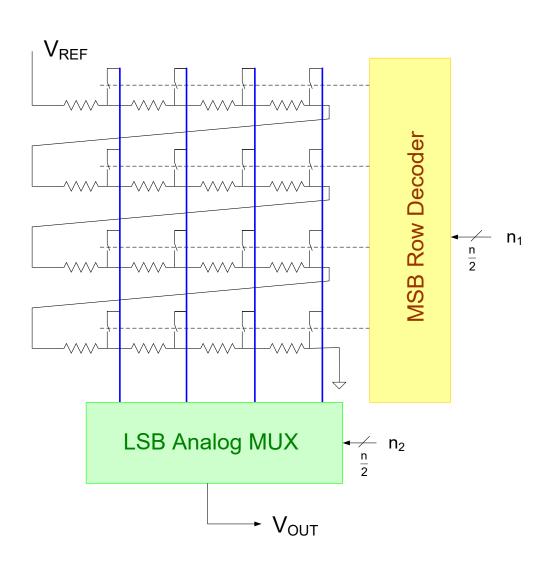
- One of the simplest DAC architectures
- R-string DAC is inherently monotone

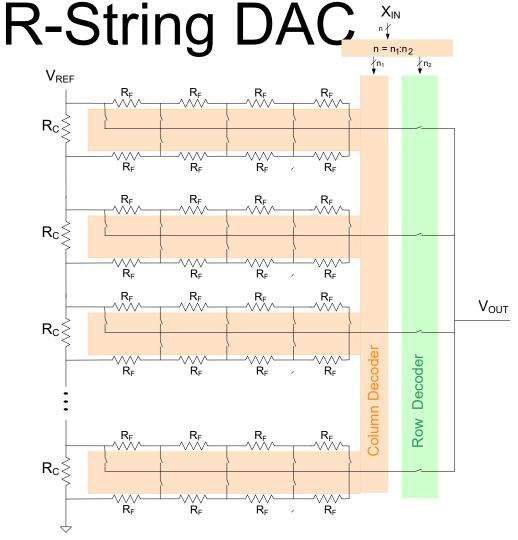
Possible Limitations or Challenges

- Binary to Thermometer Decoder (BTTD) gets large for n large
- Logic delays in BTTD may degrade performance
- Matching of the resistors may not be perfect
 - Local random variations
 - · Gradient effects
- How can switches be made?
- Lots of capacitance on output node



R-String DAC





IEEE JOURNAL OF SOLID-STATE CIRCUITS, VOL. 25, NO. 6, DECEMBER 1990

Note Dual Ladder is used!

A 10-b 50-MHz CMOS D/A Converter with 75-Ω Buffer

A 10-b 50-MHz CMOS D/A converter with 75-Ω buffer - Get It@ISU

MJM **Pelgrom** - IEEE Journal of Solid-State Circuits, 1990 - ieeexplore.ieee.org Abstracf -A 10-b 50-MHz digital-to-analog (D/A) converter is pre- sented which is based on a dual-ladder resistor string. This approach allows the linearity requirements to be met without the need for selection or trimming. The D/A ... Cited by 45 - Related articles - Web Search - All 2 versions

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A 10-b 50-MHz CMOS D/A Converter with 75-Ω Buffer

MARCEL J. M. PELGROM, MEMBER, IEEE

Abstract —A 10-b 50-MHz digital-to-analog (D/A) converter is presented which is based on a dual-ladder resistor string. This approach allows the linearity requirements to be met without the need for selection or trimming. The D/A decoding scheme reduces the glitch energy, and signal-dependent switch signals reduce high-frequency distortion. The output buffer allows driving 1 V_{pp} to 75 Ω . The chip consumes 65 mW at maximum clock frequency and a full-swing output signal. The device is processed in a standard 1.6- μ m CMOS process with a single 5-V supply voltage.

Current-based circuits dump the complementary part of the signal current to ground: the power supply current is thereby twice the average signal current. If a two-sided terminated transmission line has to be fed by the high-impedance output of the current cell D/A converter, the current should be doubled to obtain the required output swing. In this case, the power supply current is four times the average signal current. A triple video D/A converter

This paper proposes a trimless 10-b 50-MHz D/A converter based on resistor strings. This D/A converter is well suited to be used together with nearly all reported A/D converters for high speed, as these also use resistor strings to obtain the reference for the comparators. The design improves on the standard single-resistor-string approach by using a dual-ladder architecture [3] in a matrix formation [4], [5]. Several measures have been taken in the ladder to reduce the distortion. The decoding aims at minimizing the number of transistors that switch. The on-chip output buffer allows driving 1 V_{pp} to 75 Ω . The inherent voltage output allows driving a two-sided terminated transmission line with a better power efficiency than a current cell D/A converter.

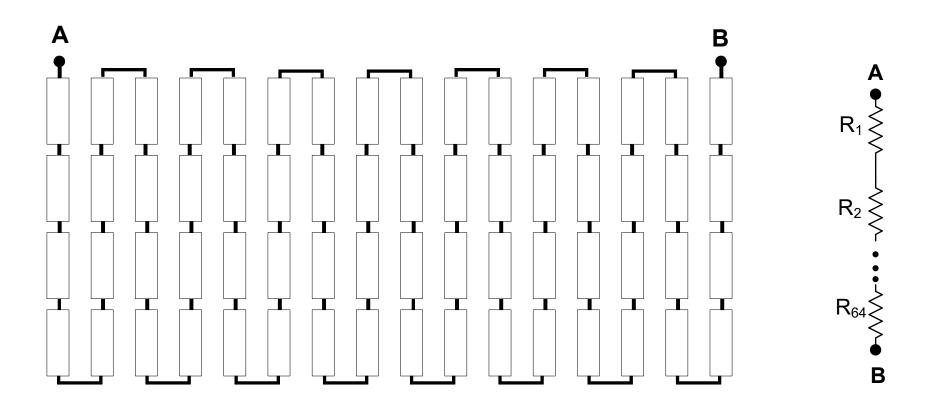
II. THE CHIP DESIGN

A. The Ladder Structure

The voltage dependence and the mutual matching of large-area polysilicon resistors allow the design of a converter with high integral and differential linearity. Basically, the variation in the polysilicon resistance value is determined by its geometry variations: the length and width variations result in local mismatches and the thickness variation gives gradients. Equally sized MOS gates suffer in addition to charge variations in the threshold voltage. However, the design of the D/A converter with a single 1024-tap resistor ladder and sufficiently fast output settling requires tap resistors in the order of 6–10 Ω . The size of such resistors in conventional polysilicon technology is such that accurate resistor matching and consequently linearity become a problem.

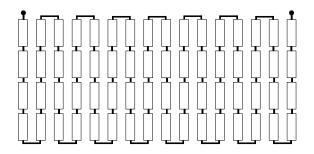
The solution to this problem is the combination of a dual ladder [3] with a matrix organization Randy Geiger Fig. 1 shows the ladder structure. The coarse ladder consists of two ladders each with 16 large-area resistors of 250 Ω which are connected anti-parallel to eliminate the firstorder resistivity gradient. The coarse ladder determines 16 accurate tap voltages and is responsible for the integral linearity. A 1024-resistor fine ladder is arranged in a 32-by-32 matrix, where every 64th tap is connected to the coarse-ladder taps. This arrangement allows the fineladder tap resistance to be increased to 75 Ω without loss of speed. The effect of wiring resistances has to be related to the 75- Ω tap resistors and can therefore be neglected. There are only currents in the connections between the ladders in the case of ladder inequalities: this reduces the effect of contact resistance variance. The current density in the polysilicon is kept constant to avoid field-dependent nonlinearities. The coarse ladder is designed with polysilicon resistors in order to avoid voltage dependence of diffused resistors. The fine ladder is designed either in polysilicon or diffusion, depending on secondary effects in the process implementation.

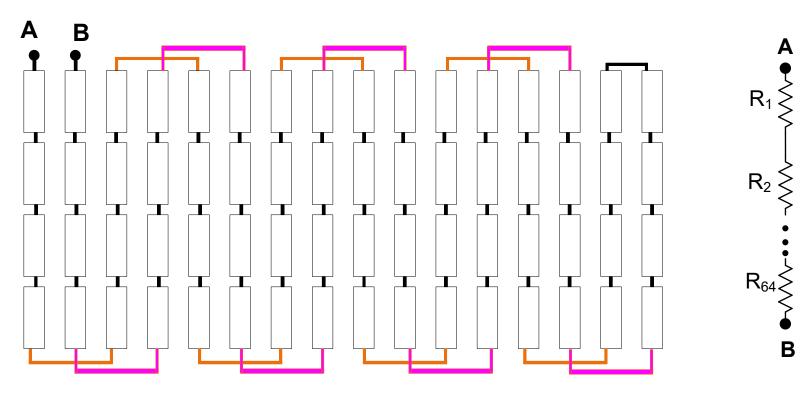
Resistor Layout



Standard Series Layout of 64 resistors

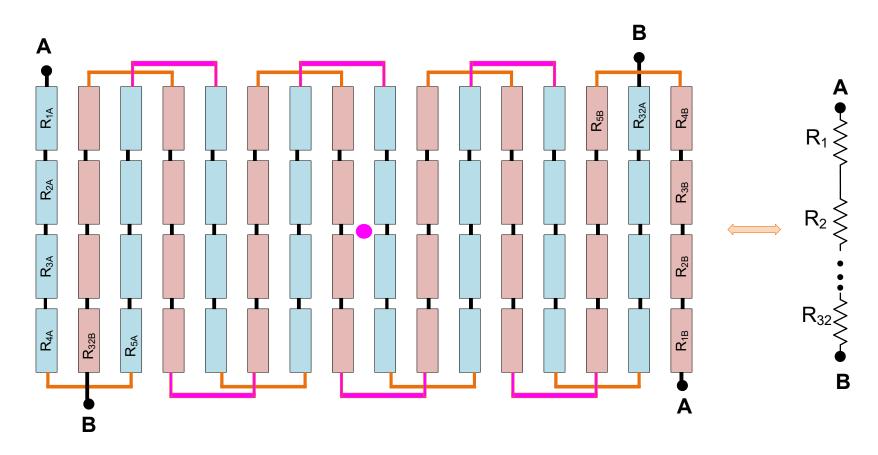
Resistor Layout





Layout of 64 resistors with reduced gradient sensitivity

Resistor Layout



Antiparallel Layout of 32 resistors with Common Centroid

(Pelgrom used only 16 resistors)

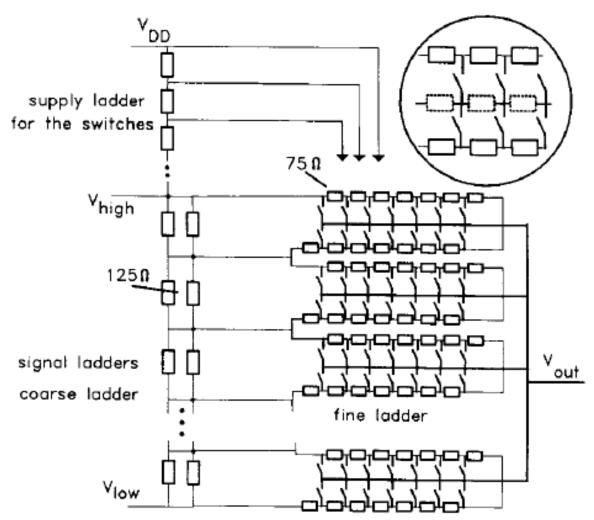


Fig. 1. Resistor network for the video D/A converter.

In a basic ladder design consisting of one string of 1024 resistors, the output impedance of the structure varies with the selected position on the ladder and therefore with the applied code. The varying output impedance in combination with the load capacitance results in unequal output charging time and consequently signal distortion of high-frequency output signals. This source of varying impedance has been eliminated by means of a resistive output rail. The insert in Fig. 1 shows a part of two rows of the matrix. Small resistors are placed in the output rail which connects the switches together. These resistors can be chosen in such a way that any path from the beginning of the resistor row to the end of the output rail shows the same impedance, independent of the chosen switch. This eliminates position-dependent charging of the output rail

and therefore reduces the odd harmonics. In this design, partial cancellation was achieved by placing a unity resistor at the appropriate positions in the output rail. The use of unity resistors keeps the layout simple and does not require additional chip area.

The second source of the varying output impedance is the switch transistor. Usually its on-state gate voltage equals the positive power supply; the voltage on its source terminal, however, is position dependent. The turn-on voltage doubles from one end of the ladder to the other. In this design an additional supply ladder is placed on top of the signal ladders to keep the turn-on voltage of the switches more constant. Effectively the turn-on voltage of each switch transistor is made equal to the lowest turn-on voltage of a basic ladder D/A structure. Therefore there are no additional power supply constraints. For an easy implementation, the switches along each output rail have a common supply line. The variation in turn-on voltage is thereby reduced by a factor of 16. The upper group of switches is fed from the power supply while each lower group is fed with a voltage lowered by one-sixteenth of the maximum signal swing. An additional advantage of this compensation is that the impedance of the switch can be in the order of the total ladder resistance: the switches reduce in width and consequently the clock feedthrough is also reduced.

B. The Digital Decoder

The core of the D/A converter is formed by the 32-by-32 fine-resistor matrix. A switch and a two-input AND gate1 are connected to each fine resistor to form a basic cell. Two rows of 32 cells each are arranged around one output rail to form one of the 16 sections of the 10-b D/A converter (see Fig. 2). In operation one of the tap voltages of the fine ladder is switched to one of the 16 output rails of the matrix and subsequently to the input of the buffer. In order to select the proper switch, the 10-b digital input word is split in two 5-b words which are decoded by two sets of 5-to-32 decoders, as shown in Fig. 2. The 5-to-32 decoding is performed in two steps: a predecoder converts into ten lines that control 32 threeinput NOR gates of which one gate is activated. In this way minimum capacitive load is driven and maximum speed is achieved. The two decoders are placed on two sides of the matrix. The two sets of 32 decoded lines are latched by the main clock before running horizontally and verti-

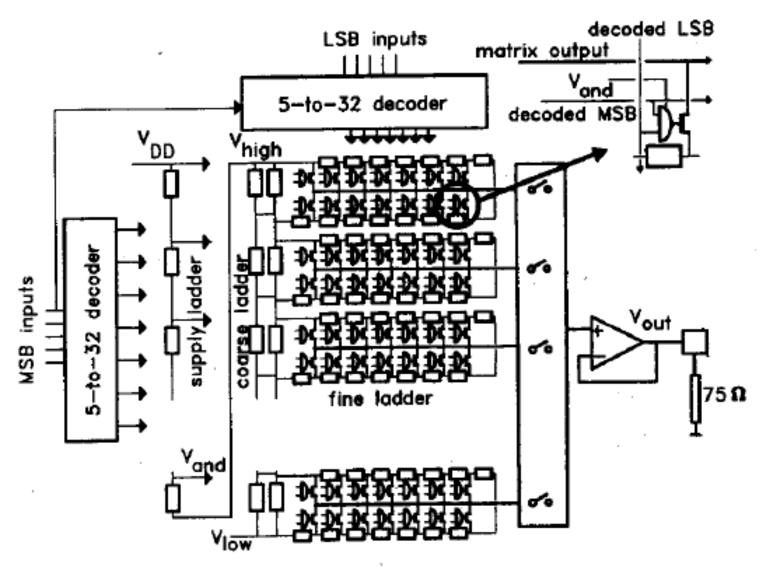


Fig. 2. Block diagram of the D/A converter.

Another key paper for matching-critical circuits:

<u>Matching properties of MOS transistors</u>

[PDF] unipi.it

MJM Pelgrom, ACJ Duinmaijer... - IEEE Journal of solid ..., 1989 - ieeexplore.ieee.org

The **matching properties** of the threshold voltage, substrate factor, and current factor of **MOS transistors** have been analyzed and measured. Improvements to the existing theory are ...

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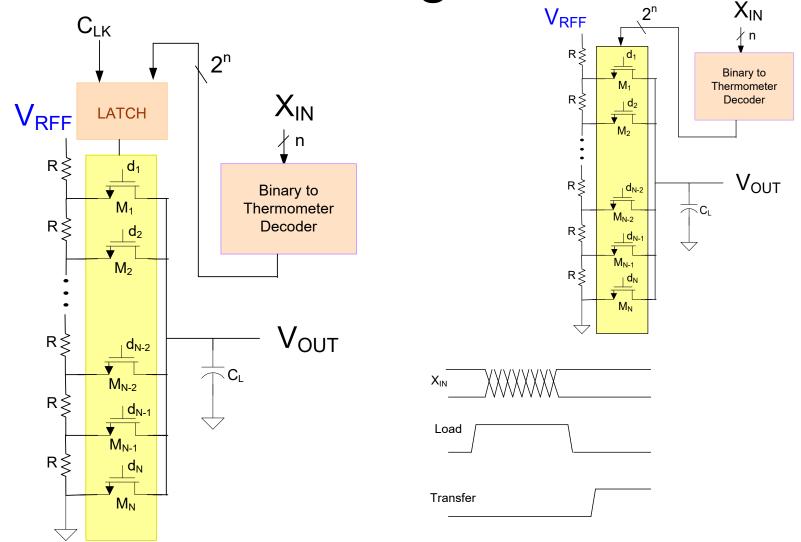
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Second most cited paper in the IEEE Journal of Solid State Circuits

Most cited basic research paper in IEEE Journal of Solid State Circuits

Basic R-String DAC



Latching Boolean Signal Can Reduce/Eliminate Logic Transients which Cause Distortion

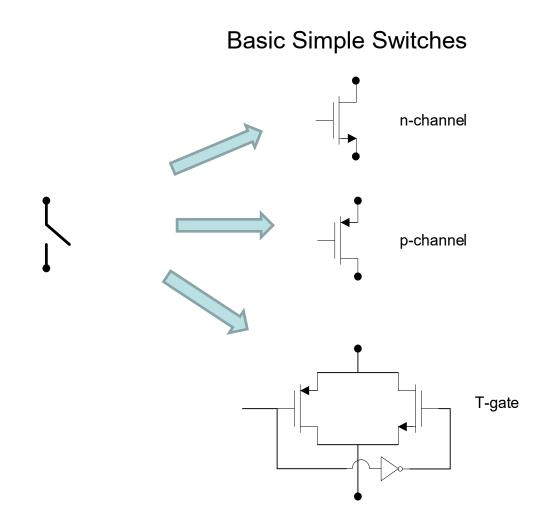
V_{REF} R/4 b₁ n_1 bits b_2 R∮ RŚ 2ⁿ-1 Resistors V_{OUT} n₂ bits R≷ R/4 n₁ bits

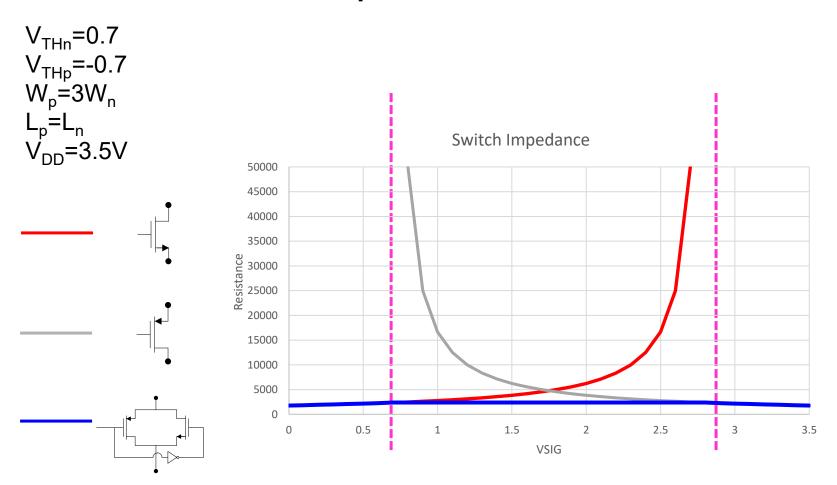
Basic R-String DAC

For all b_1 and b_2 , $R_U+R_I=R$

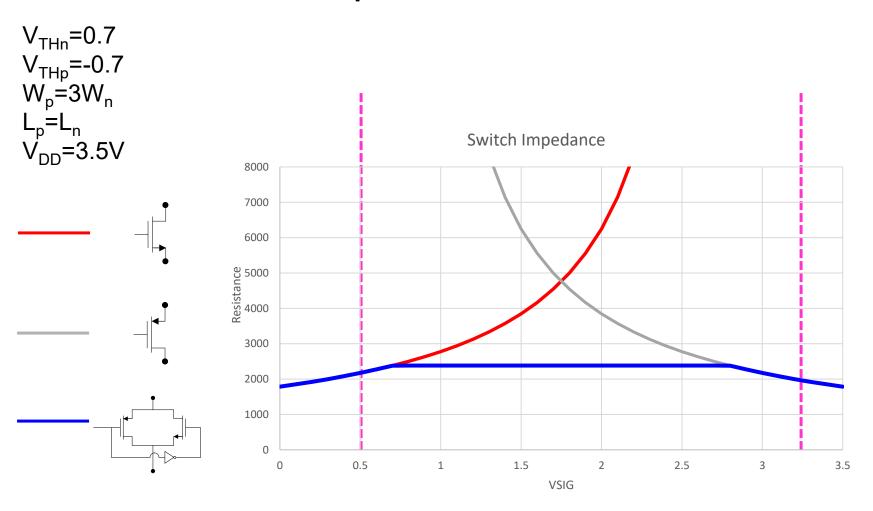
- Another Segmented DAC structure
- Can be viewed as a "dither" DAC
- Often n₁ is much smaller than n₂
- Dither can be used in other applications as well

Switches used extensively in data converters! Switch Implementation Issues

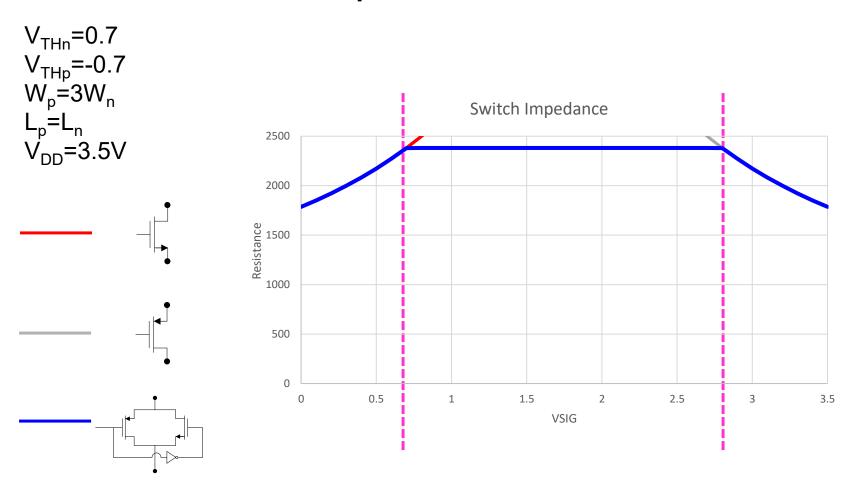




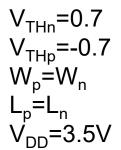
 V_{SIG} : Voltage on switch when ON



 V_{SIG} : Voltage on switch when ON

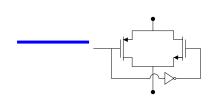


Transmission Gate Impedance Can be Reasonably constant

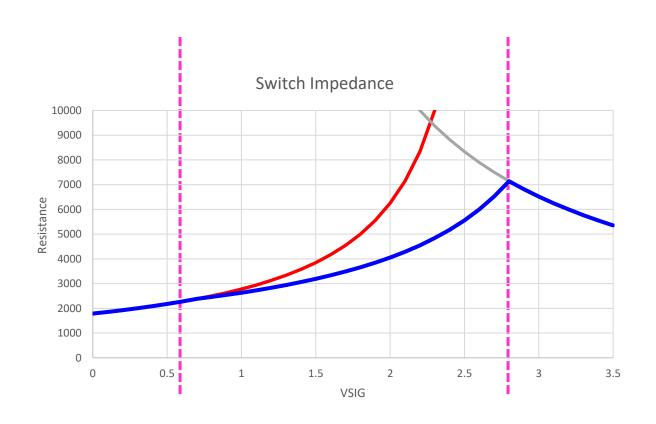


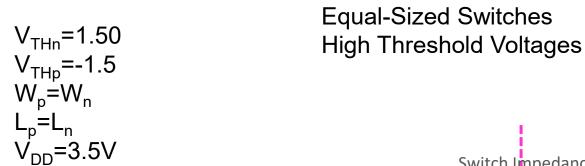


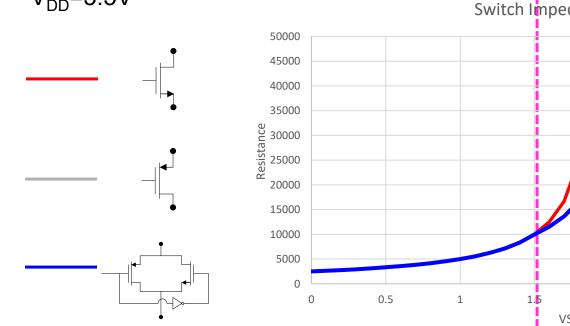


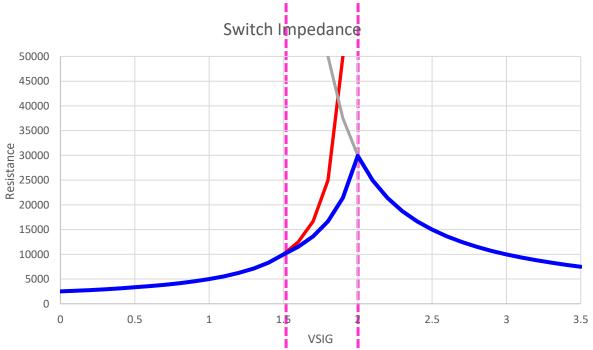


Equal-Sized Switches

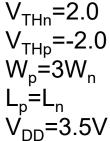




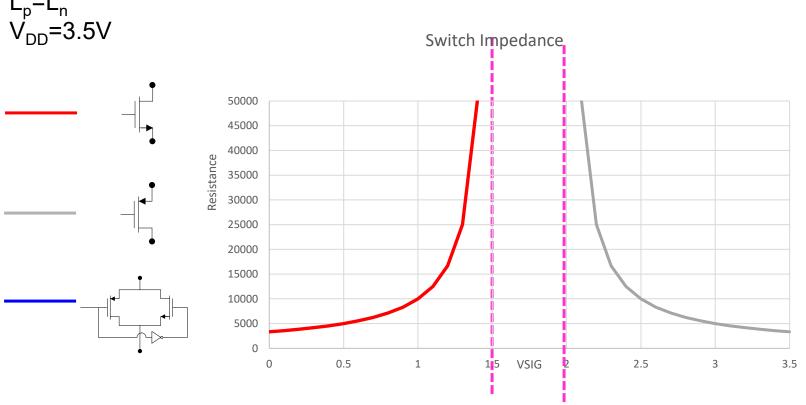




Even Transmission Gate Does Not Perform Well



Tough unlikely, this is what would happen if very high threshold devices were used

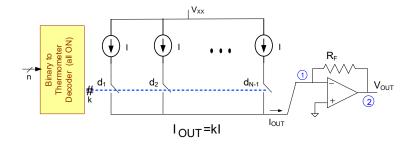


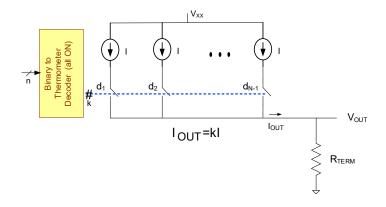
Gap where neither switch is working

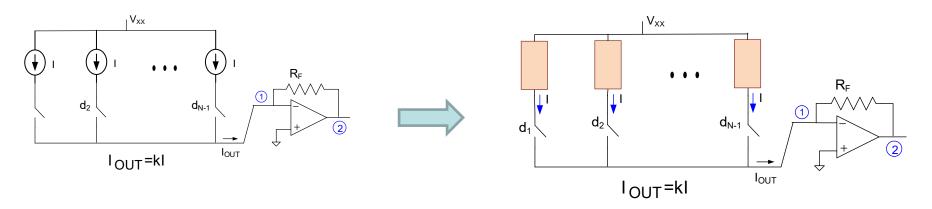
Current will be "steered" to a resistive load (on chip)

Output could be a current (user supplies load)

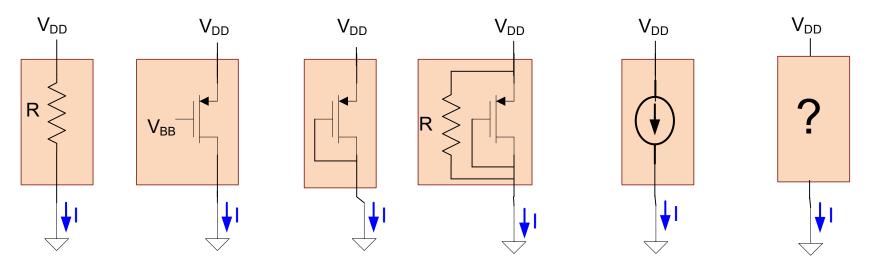
Basic Concept of Current Steering DACs



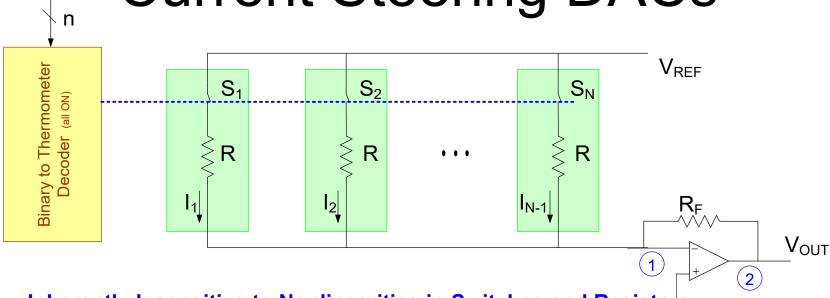




What is important is the current generated, not whether it comes from a "current source"

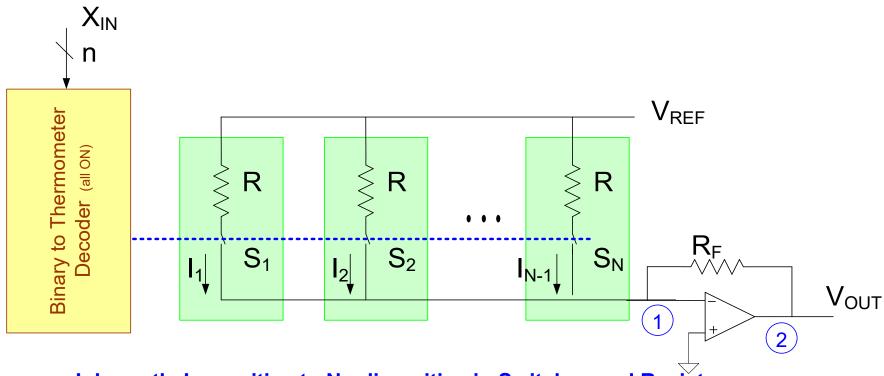


Many potential current generator blocks, just require that all be ideally identical



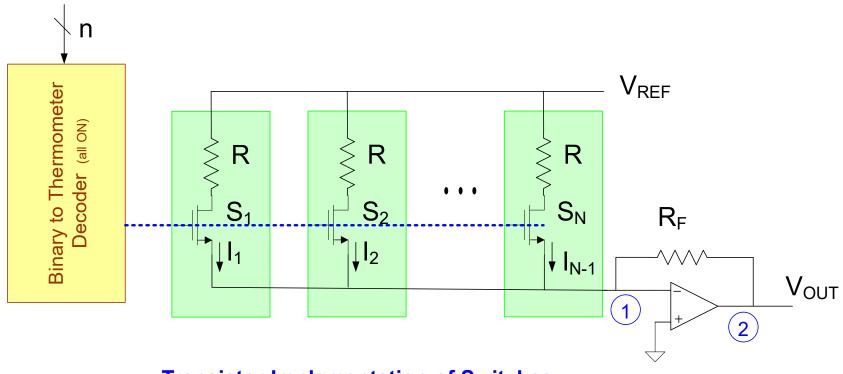
Inherently Insensitive to Nonlinearities in Switches and Resistors

- Termed "top plate switching"
- · Thermometer coding
- Excellent DNL properties
- INL may be poor, typically near mid range
- INL is a random variable with variance approximately proportional to area
- Area gets large for good yield with large n
- Each additional bit of resolution requires a factor of 2 increase in area if same sized resistors are used
- Each additional bit of resolution requires another factor of 4 increase in area to maintain the same yield

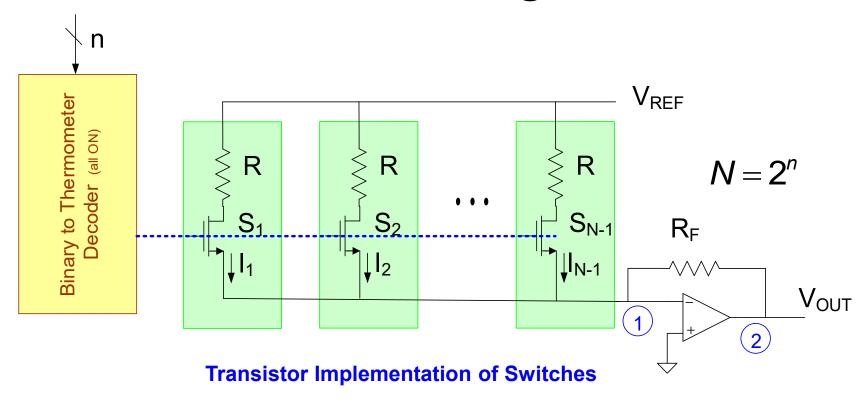


Inherently Insensitive to Nonlinearities in Switches and Resistors Smaller ON resistance and less phase-shift from clock edges

- Termed "bottom plate switching"
- Thermometer coded



Transistor Implementation of Switches



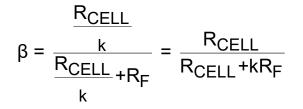
How should the op amp be compensated?

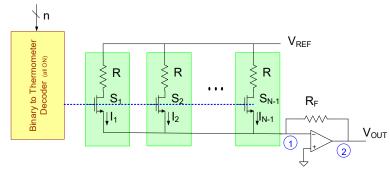
Assume k switches are on 0<k<N-1

$$\beta = \frac{\frac{R_{CELL}}{k}}{\frac{R_{CELL}}{k} + R_{F}} = \frac{R_{CELL}}{R_{CELL} + kR_{F}}$$
If $V_{OUTFS} = V_{REF}$ $R_{CELL} = NR_{F}$

$$0.5 < \beta \le 1$$

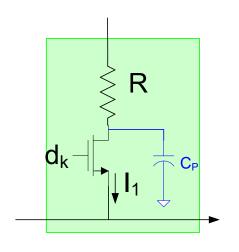
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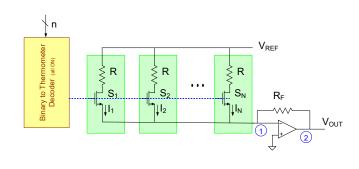




$$V_{OUTFS} = V_{REF}$$

$$0.5 < \beta \le 1$$





Problem?

Switch impedance No

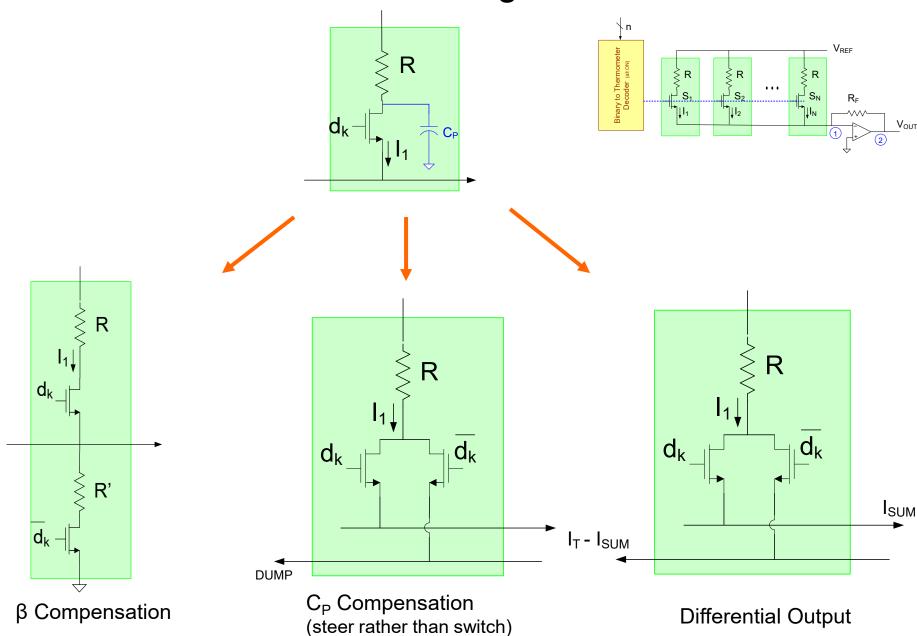
Code-dependent phase margin Yes

Single-ended output Yes

 C_P Yes

Binary to Thermometer Decoder Yes

Op Amp Bandwidth Yes





Stay Safe and Stay Healthy!

End of Lecture 33